

B120/B - B160/B

## **1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER**

### **Features**

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 30A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony)
  (Note 2)

## **Mechanical Data**

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
   (3)
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See page 3
- Ordering Information: See page 3
- Weight: SMA 0.064 grams (approximate) SMB 0.093 grams (approximate)



Top View

Bottom View

## **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.							
Characteristic	Symbol	B120/B	B130/B	B140/B	B150/B	B160/B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> Vr	20	30	40	50	60	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	21	28	35	42	V
Average Rectified Output Current @ T <sub>T</sub> = 130°C	lo			1.0			А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>			30			А

# Thermal Characteristics

Characteristic	Symbol	B120/B	B130/B	B140/B	B150/B	B160/B	Unit
Typical Thermal Resistance Junction to Terminal (Note 3)	$R_{\theta JT}$			20			°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>			-65 to +150			°C

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Chara	cteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B120/B, B130/B, B140/B B150/B, B160/B	V-		-	0.5 0.7	V	I <sub>F</sub> = 1.0A I <sub>F</sub> = 1.0A
Leakage Current (Note 4)		I <sub>R</sub>	-	-	0.5 10	mA	@ Rated $V_{R,} T_{A} = 25^{\circ}C$ @ Rated $V_{R,} T_{A} = 100^{\circ}C$
Total Capacitance		Ст	-	-	110	рF	$V_R = 4V, f = 1MHz$

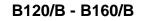
Notes:

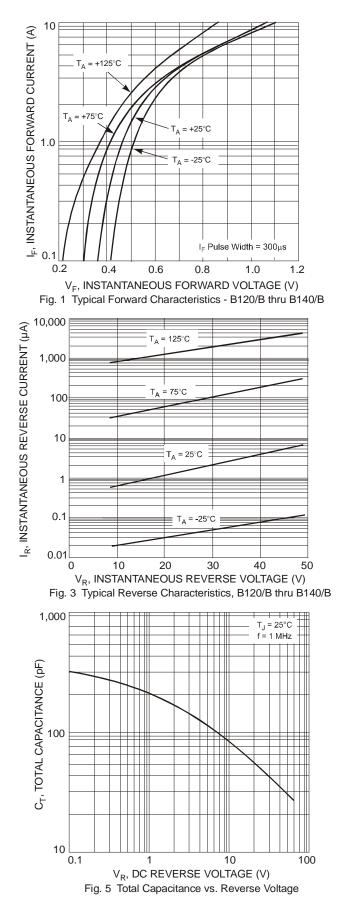
EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/quality/lead\_free.html.
 Product manufactured with Data Code 0924 (week 24, 2009) and never are built with Green Molding Compound.

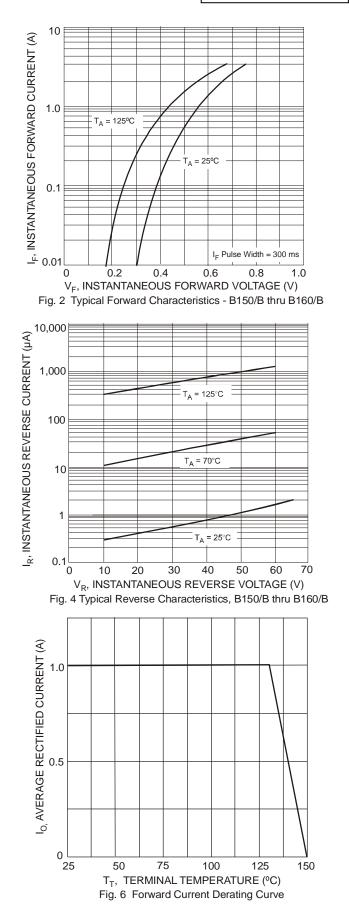
3. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm<sup>2</sup> (0.013 mm thick) copper pads as heat sink.

4. Short duration pulse test used to minimize self-heating effect.

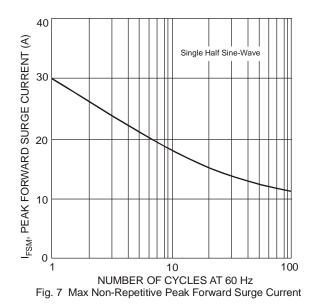












# Ordering Information (Note 5)

Part Number	Case	Packaging
B1XX-13-F	SMA	5000/Tape & Reel
B1XXB-13-F	SMB	3000/Tape & Reel

\*xx = Device Type, e.g. B120-13-F (SMA Package); B120B-13-F (SMB Package).

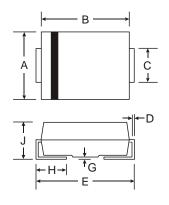
Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Marking Information**



B1X0 = Product type marking code, ex: B120 (SMA package) B1X0B = Product type marking code, ex: B160B (SMB package) Cill = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code 01 to 52

# **Package Outline Dimensions**

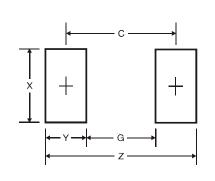


	SMA	
Dim	Min	Max
Α	2.29	2.92
В	4.00	4.60
С	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
Н	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

	SMB	
Dim	Min	Max
Α	3.30	3.94
В	4.06	4.57
С	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
н	0.76	1.52
J	2.00	2.62
All Dim	ensions	in mm



## **Suggested Pad Layout**



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Y	2.5
С	4.0
-	
-	1
SMB Dimensions	Value (in mm)
-	Value (in mm) 6.7
Dimensions	· · ·
Dimensions Z	6.7
Dimensions Z G	6.7 1.8

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